

FQA13N50CF

500V N-Channel MOSFET

Features

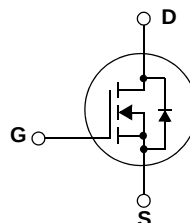
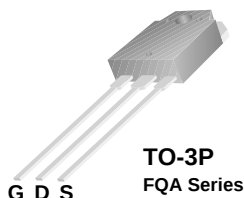
- 15A, 500V, $R_{DS(on)} = 0.48\Omega$ @ $V_{GS} = 10V$
- Low gate charge (typical 43nC)
- Low C_{rss} (typical 20pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- Fast recovery body diode (typical 100ns)
- RoHS compliant



Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies, active power factor correction, electronic lamp ballast based on half bridge topology.



Absolute Maximum Ratings

Symbol	Parameter	FQA13N50CF	Units
V_{DSS}	Drain-Source Voltage	500	V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	15	A
	- Continuous ($T_C = 100^\circ\text{C}$)	9.5	A
I_{DM}	Drain Current - Pulsed (Note 1)	60	A
V_{GSS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy (Note 2)	860	mJ
I_{AR}	Avalanche Current (Note 1)	15	A
E_{AR}	Repetitive Avalanche Energy (Note 1)	21.8	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5	V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	218	W
	- Derate above 25°C	1.56	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	--	0.58	$^\circ\text{C/W}$
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink	0.24	--	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	--	40	$^\circ\text{C/W}$

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQA13N50CF	FQA13N50CF	TO-3P	--	--	30
FQA13N50CF	FQA13N50CF_F109	TO-3PN	--	--	30

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units	
Off Characteristics							
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	500	--	--	V	
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	--	0.5	--	V/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V	--	--	1	μA	
		V _{DS} = 400 V, T _C = 125°C	--	--	10	μA	
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	--	--	100	nA	
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V	--	--	-100	nA	
On Characteristics							
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0	--	4.0	V	
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 7.5A	--	0.43	0.48	Ω	
g _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 7.5 A (Note 4)	--	15	--	S	
Dynamic Characteristics							
C _{iSS}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	--	1580	2055	pF	
C _{oSS}	Output Capacitance		--	180	235	pF	
C _{rSS}	Reverse Transfer Capacitance		--	20	25	pF	
Switching Characteristics							
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250 V, I _D = 15A, R _G = 25 Ω	--	25	60	ns	
t _r	Turn-On Rise Time		--	100	210	ns	
t _{d(off)}	Turn-Off Delay Time		(Note 4, 5)	--	130	270	ns
t _f	Turn-Off Fall Time			--	100	210	ns
Q _g	Total Gate Charge	V _{DS} = 400 V, I _D = 15A, V _{GS} = 10 V	--	43	56	nC	
Q _{gs}	Gate-Source Charge		(Note 4, 5)	--	7.5	--	nC
Q _{gd}	Gate-Drain Charge			--	18.5	--	nC
Drain-Source Diode Characteristics and Maximum Ratings							
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	15	A	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	60	A	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 15 A	--	--	1.4	V	
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 15 A, dI _F / dt = 100 A/μs	--	100	--	ns	
Q _{rr}	Reverse Recovery Charge	(Note 4)	--	0.4	--	μC	

NOTES:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 5.6mH, I_{AS} = 15A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C
3. I_{SD} ≤ 15A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%
5. Essentially independent of operating temperature

Typical Performance Characteristics

Figure 1. On-Region Characteristics

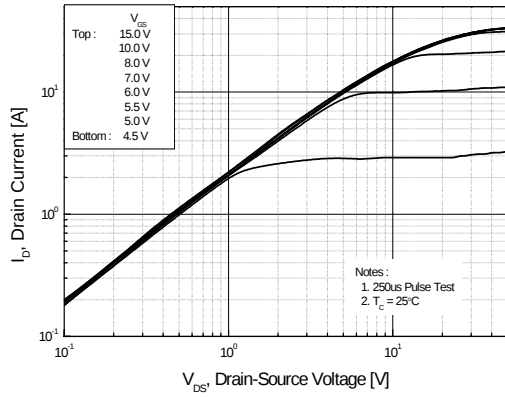


Figure 2. Transfer Characteristics

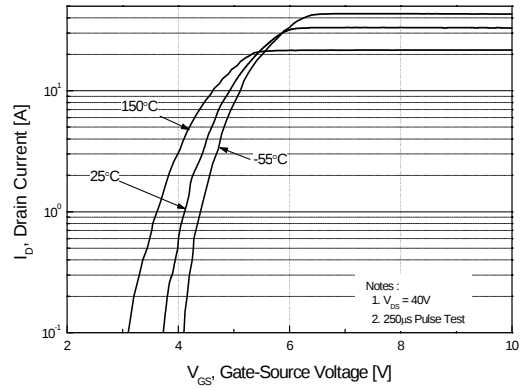


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

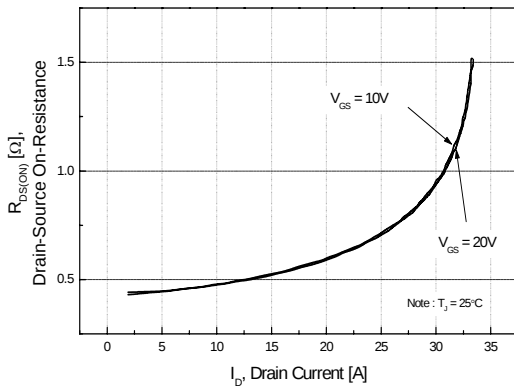


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

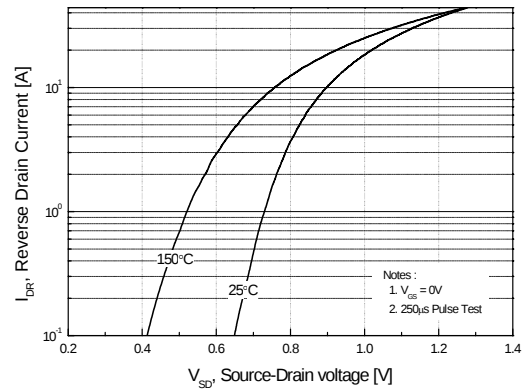


Figure 5. Capacitance Characteristics

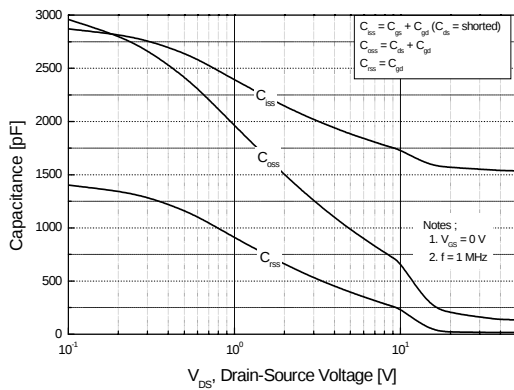
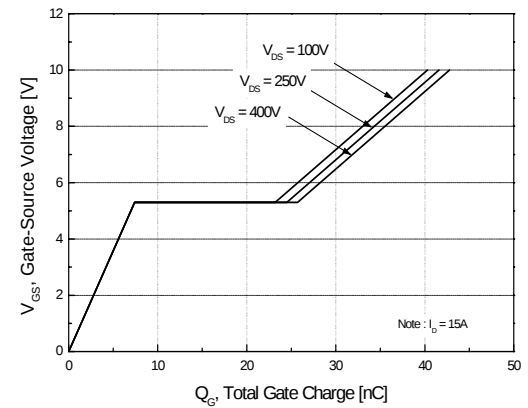


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

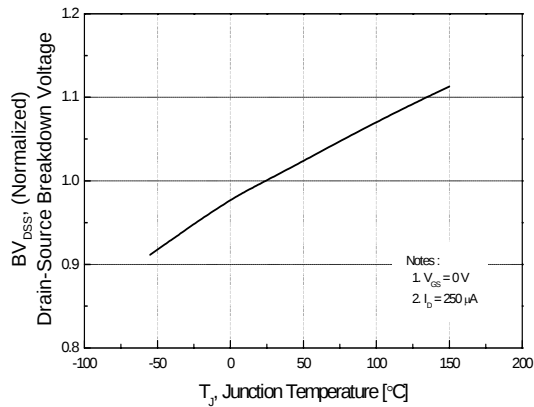


Figure 8. On-Resistance Variation vs. Temperature

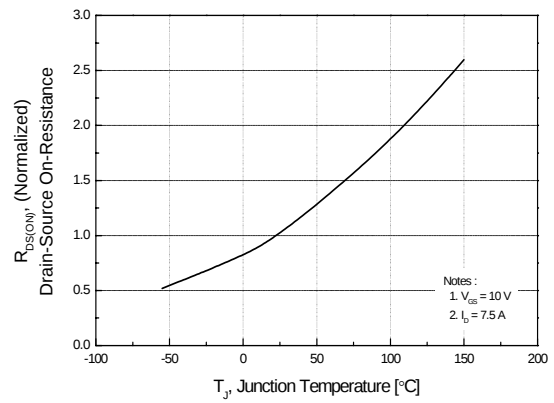


Figure 9. Maximum Safe Operating Area

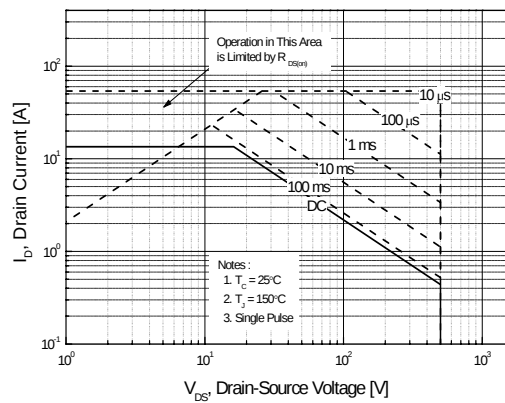


Figure 10. Maximum Drain Current vs. Case Temperature

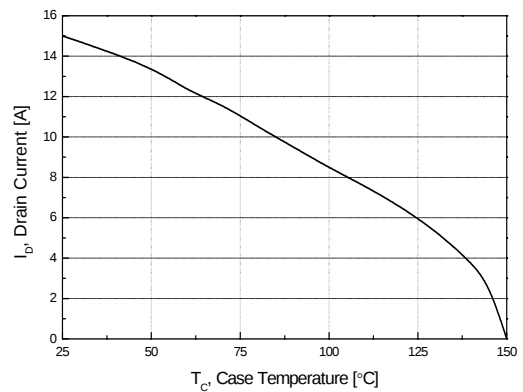
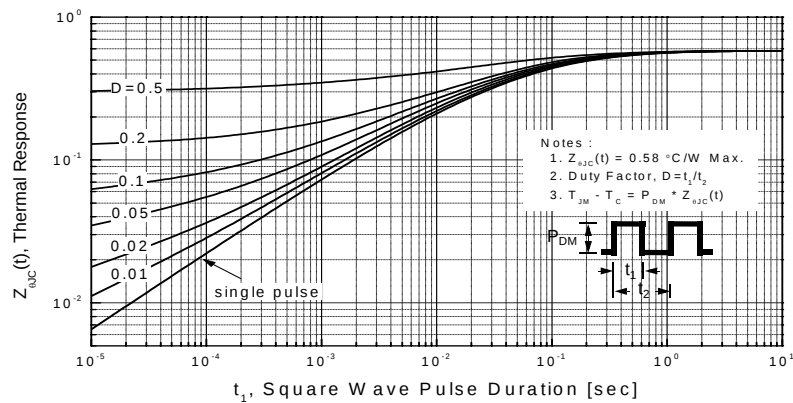


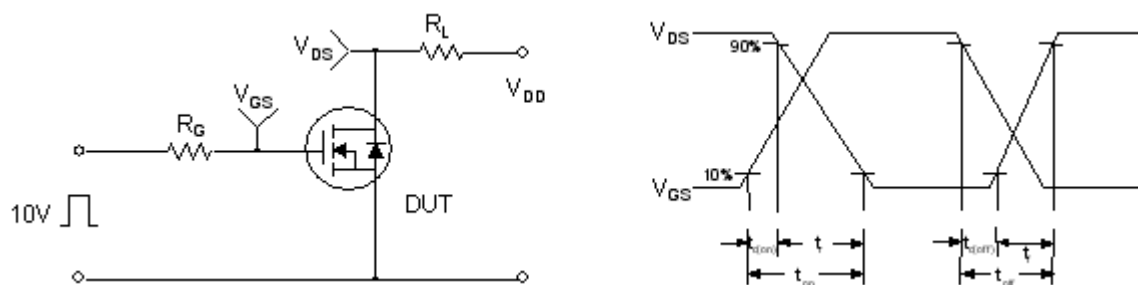
Figure 11. Transient Thermal Response Curve



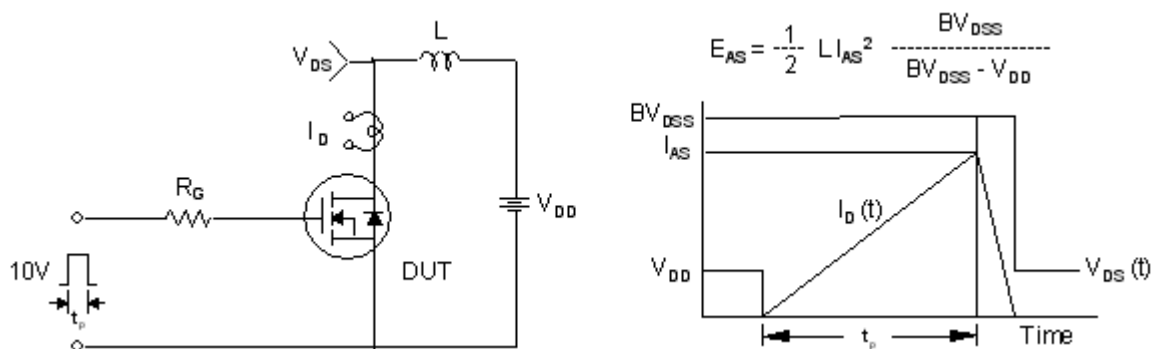
Gate Charge Test Circuit & Waveform

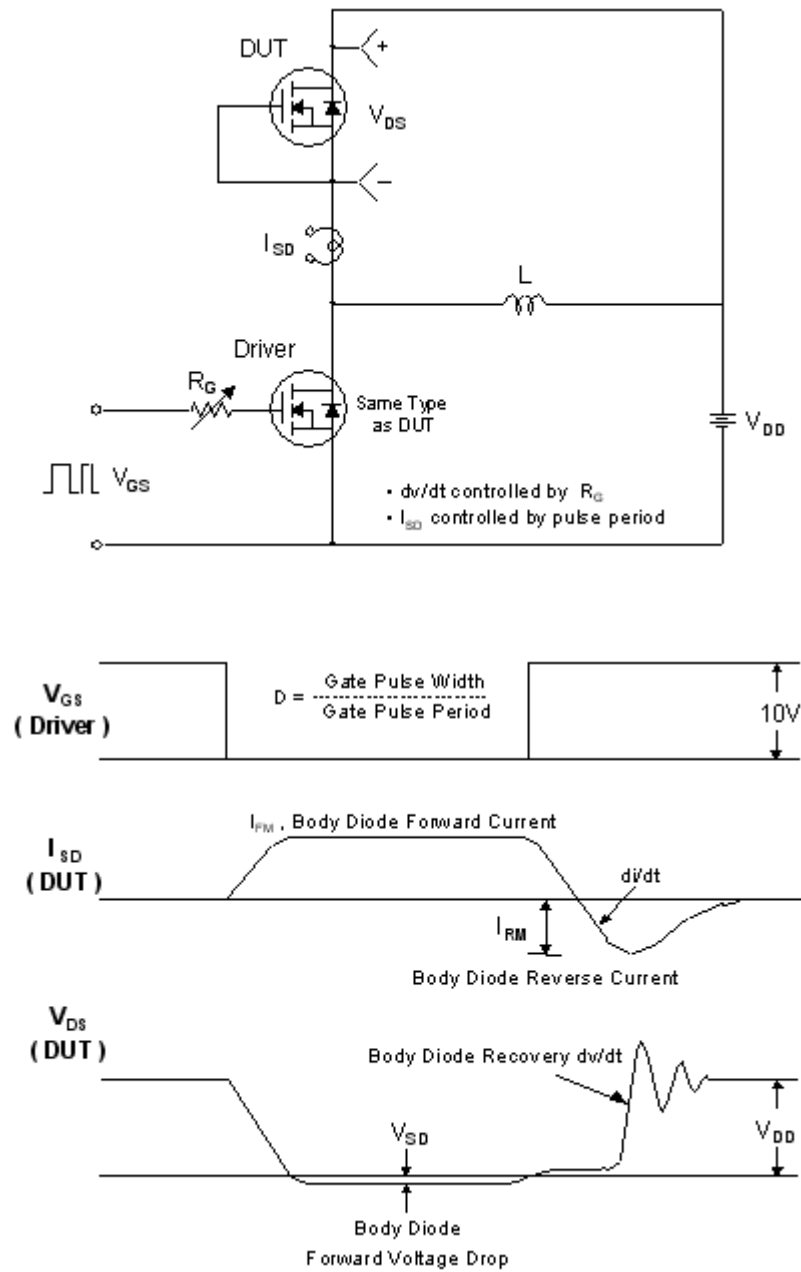


Resistive Switching Test Circuit & Waveforms



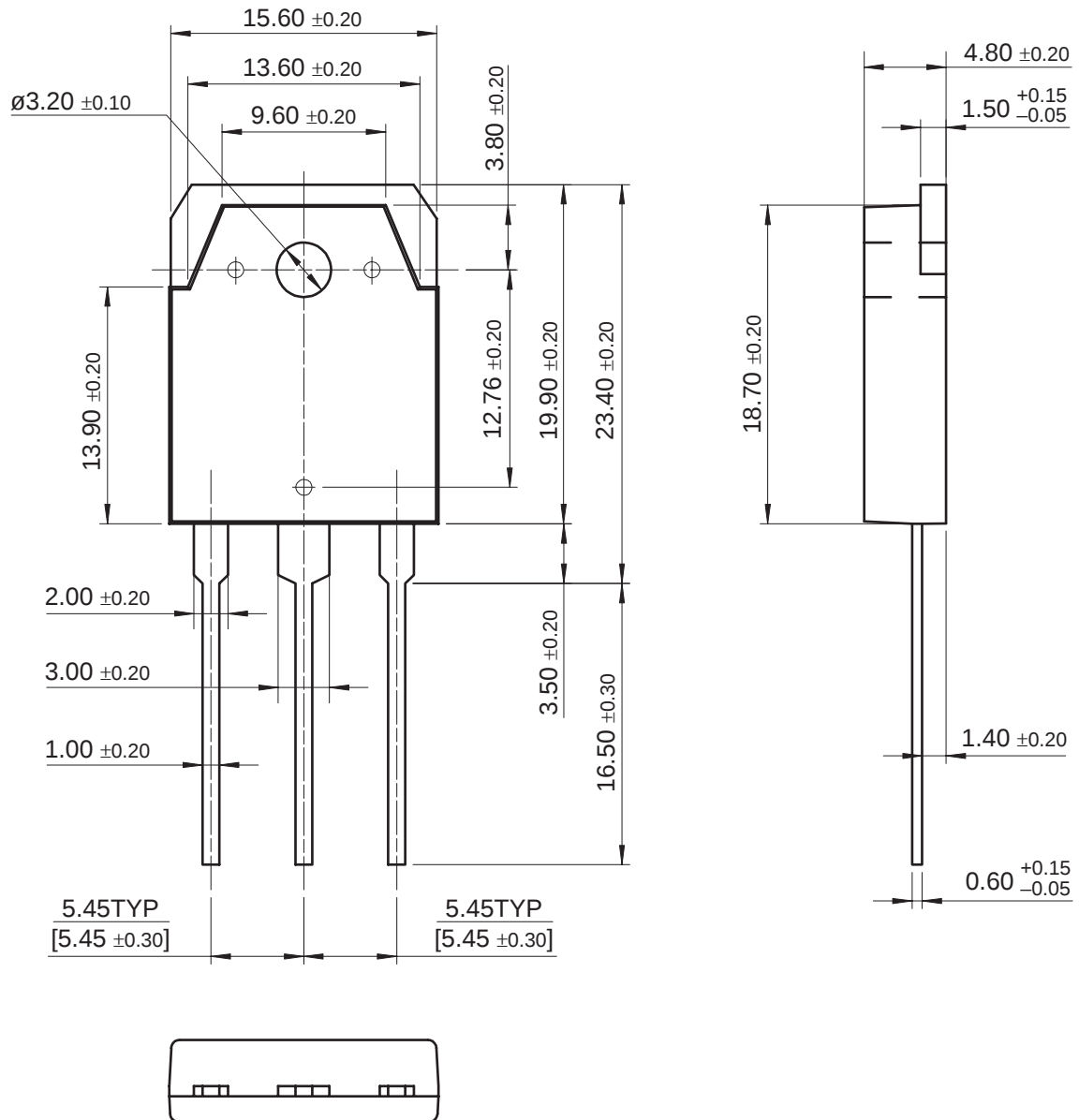
Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

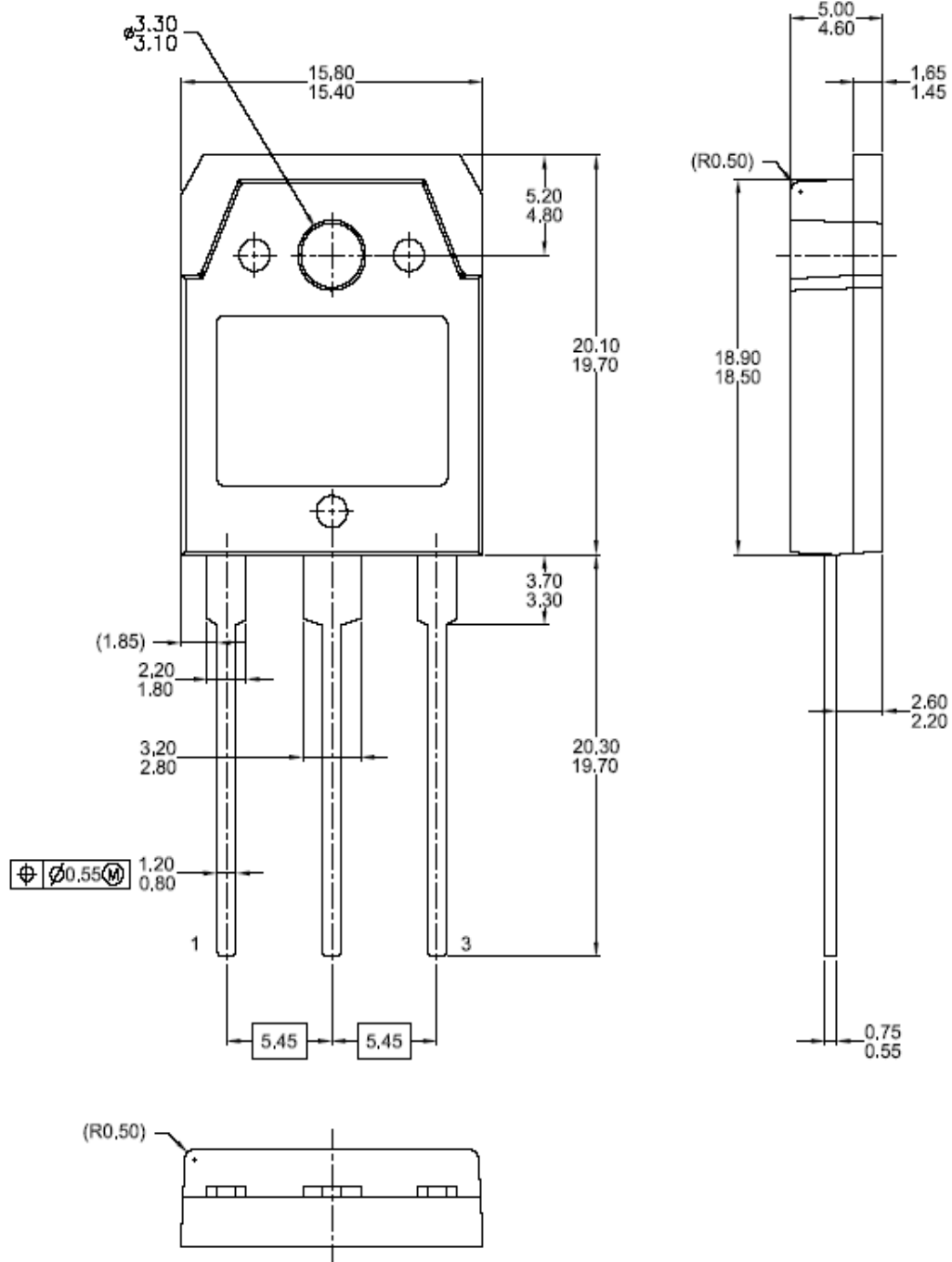
TO-3P



Dimensions in Millimeters

Mechanical Dimensions (Continued)

TO-3PN



Dimensions in Millimeters



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